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# Extraction of Depth Information from ARXPS Data

John Wolstenholme

# Theta Probe Features

- X-ray monochromator with spot size from 15  $\mu\text{m}$  to 400  $\mu\text{m}$
- Real time angle resolved XPS analysis without sample tilting



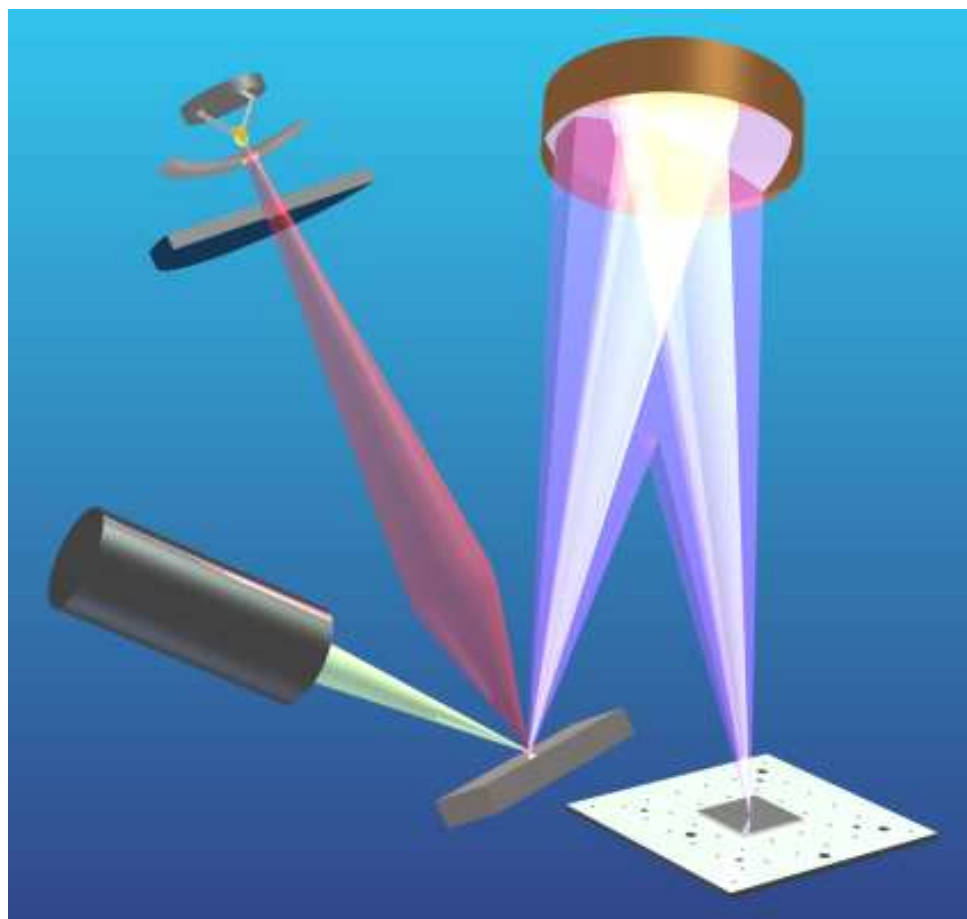
# Theta 300XT



- Parallel ARXPS from 300 mm wafers

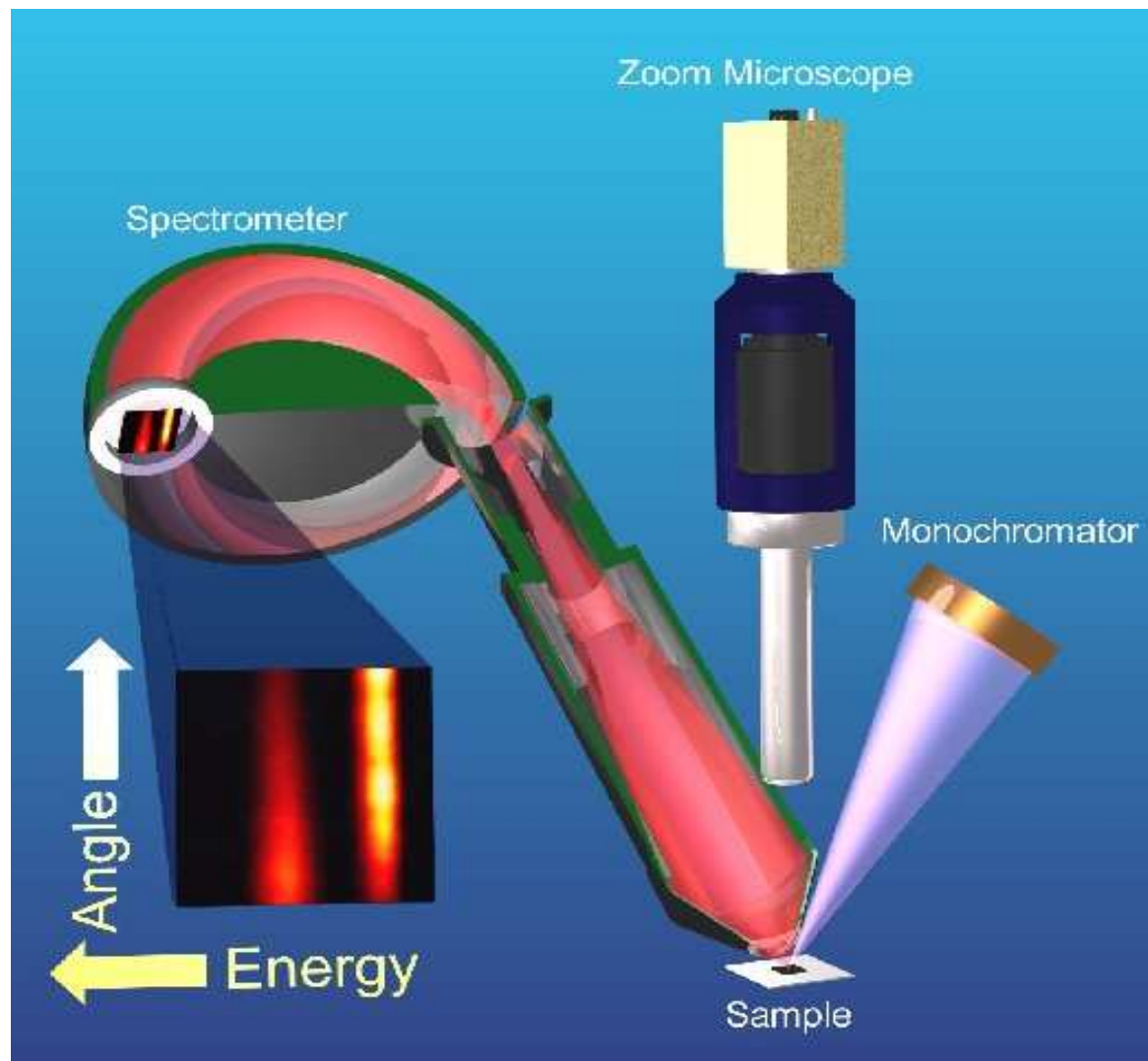


# Microfocusing Monochromator

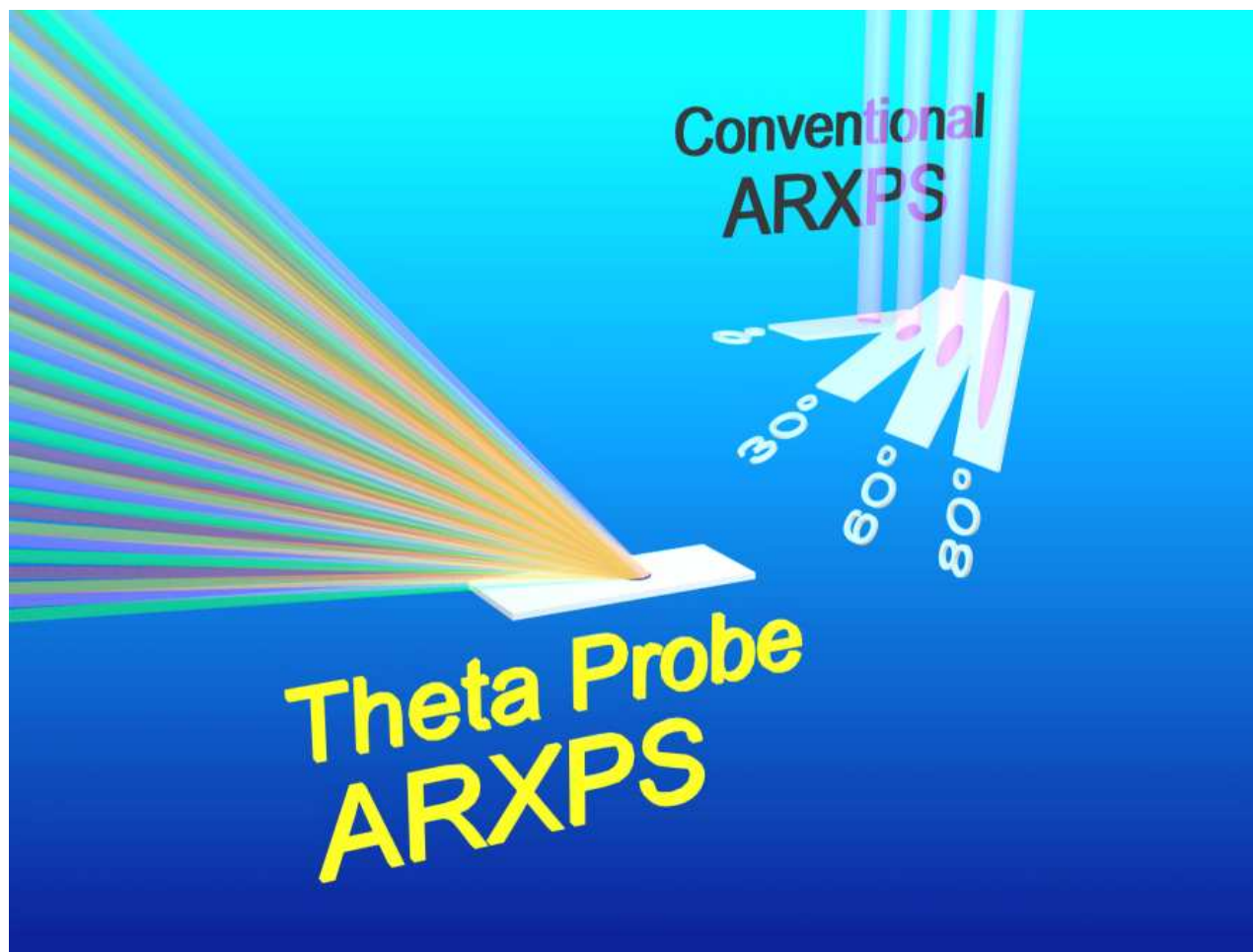


15  $\mu\text{m}$  – 400  $\mu\text{m}$  spot size

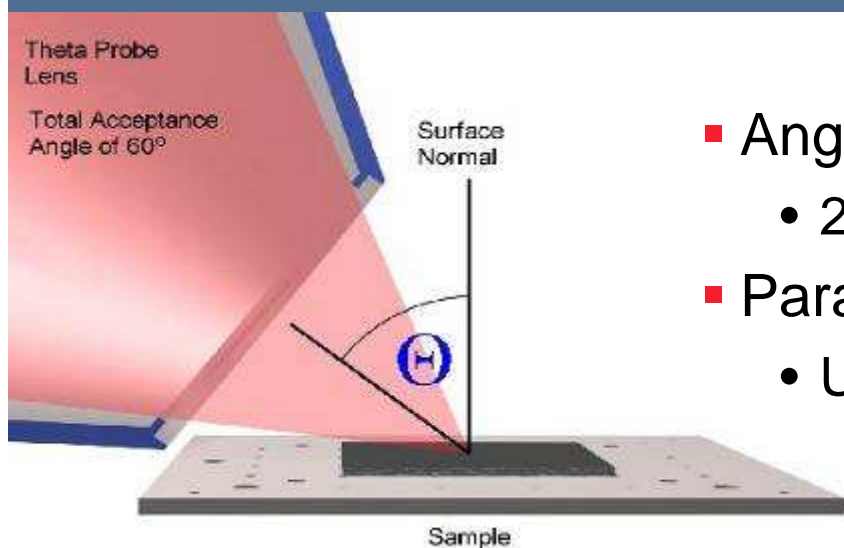
# Geometry



# Theta Probe



# Collection Conditions



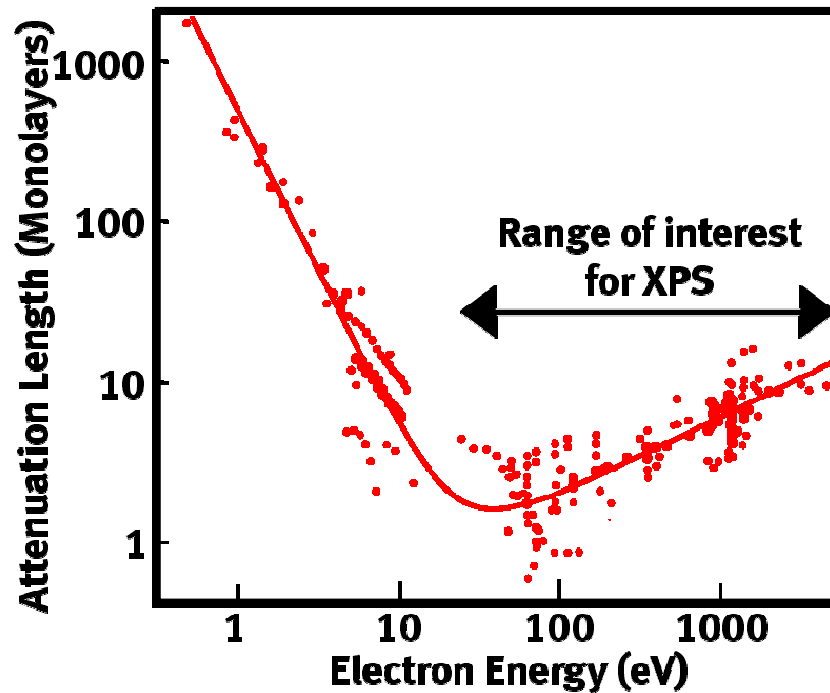
- Angular Range
  - 20° to 80°
- Parallel collection
  - Up to 96 channels in angle
    - Generally, 16 angles are used giving an angular resolution of 3.75°
  - Up to 112 channels in energy
- Parallel collection allows rapid 'snapshot acquisition'
  - Excellent for ARXPS maps
  - Thickness maps
  - Dose maps

# Data Acquisition

- Binding energy
  - Parallel (snapshot) or scanned
- Angle
  - Always parallel
- [Video of snapshot acquisition](#)
  - SiO<sub>2</sub> on Si
- Advantages of Parallel ARXPS
  - Fast
  - ARXPS from small features is possible
  - Mapping possible
  - Analysis area is constant
  - ARXPS from large samples

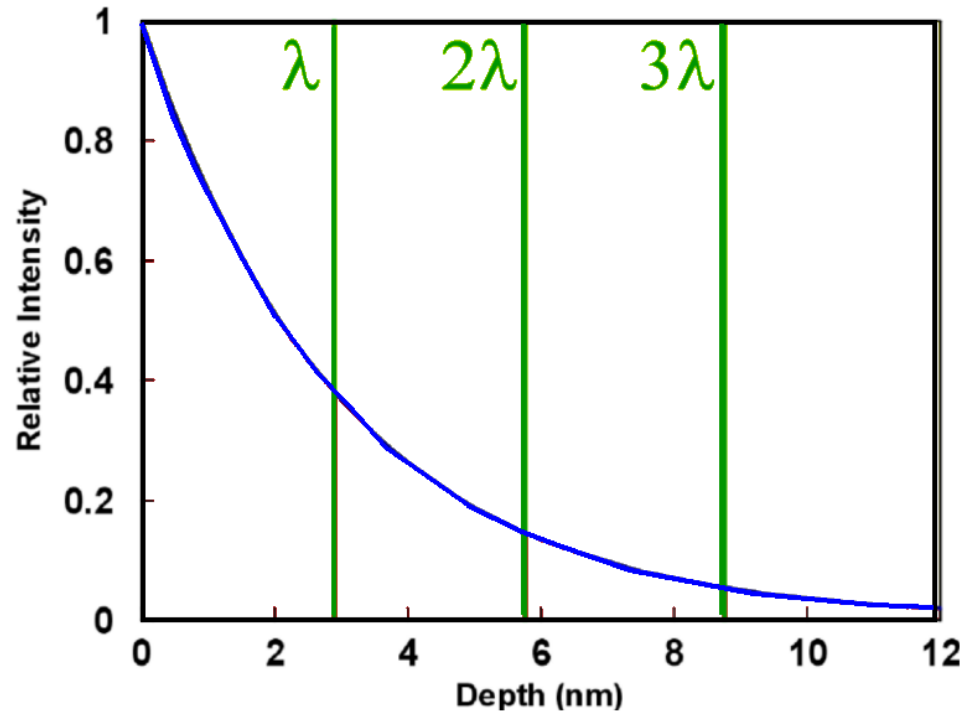


# Attenuation Length



- Each data point represents a different element or transition

$$\lambda \propto E^{0.5}$$

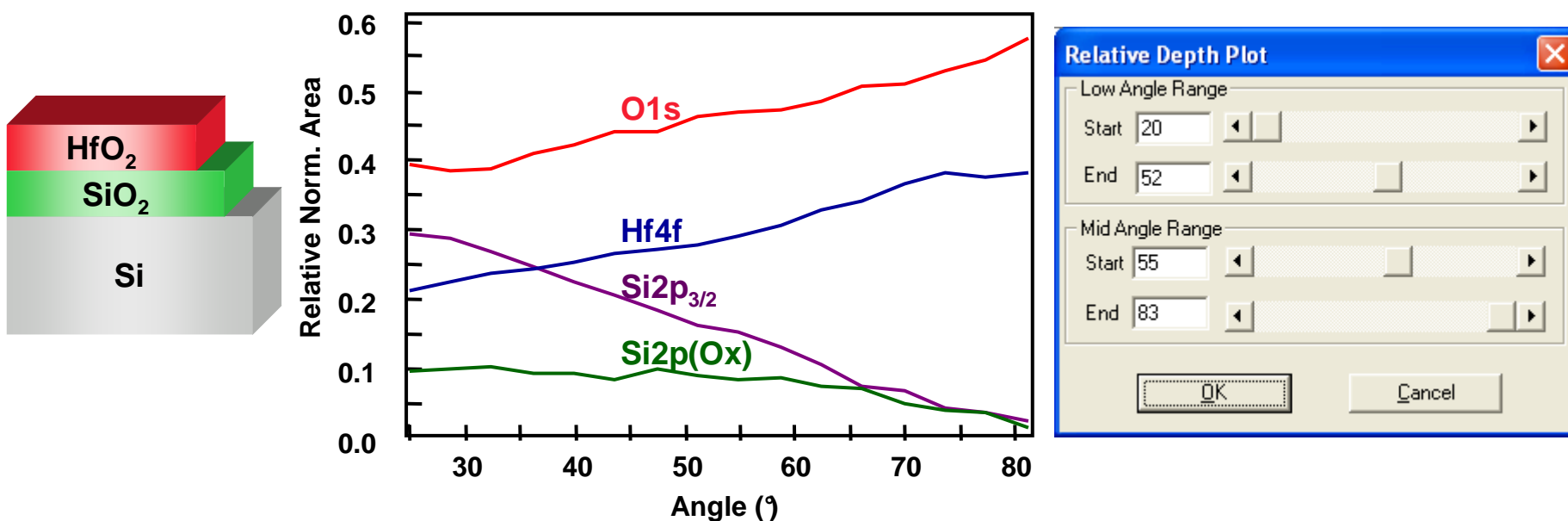


- Intensity as a function of depth
  - 65% of the signal from  $<\lambda$
  - 85% from  $<2\lambda$
  - 95% from  $<3\lambda$

M. P. Seah and W.A. Dench, Surface and Interface Analysis 1 (1979) 2

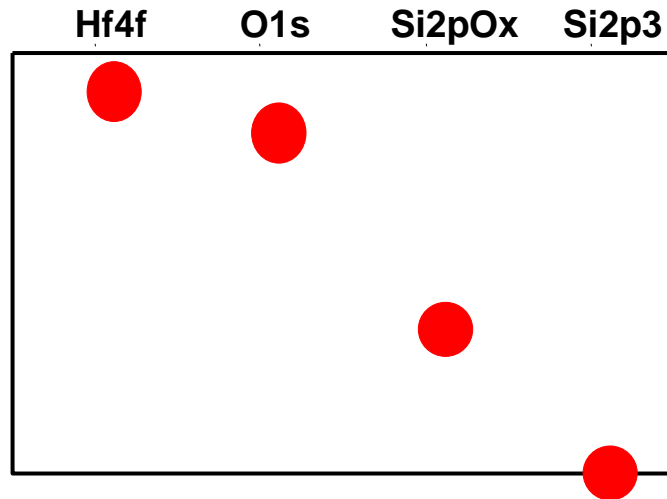
# Relative Depth Plot (RDP)

- Select range of bulk sensitive angles ( $I_{\text{bulk}}$ )
- Select range of more surface sensitive angles ( $I_{\text{surface}}$ )
- $\text{Ln} (I_{\text{surface}} / I_{\text{bulk}})$
- Provides qualitative species depth distribution

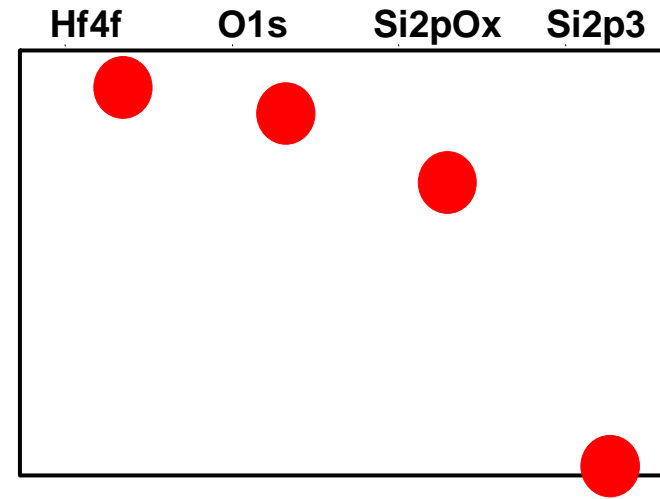


# RDP – HfO<sub>2</sub> Grown by ALD

- 30 Cycles ALD on thermal SiO<sub>2</sub>



- 30 Cycles ALD on HF-last Si



- Advantages

- Excellent for showing the ordering of the layers
- Shows gross differences between samples
- Does not rely on mathematical models
- Does not require a knowledge of the material properties

- Disadvantages

- No quantitative data
- No means to interpret the differences between samples
- Subtle differences not apparent

# Thickness Measurement

## Equations

- Photoemission from a thin film
  - $I = I_0 [1 - \exp(-d/\lambda \cos\theta)]$
- Attenuation by a thin film
  - $I = I_0 \exp(-d/\lambda \cos\theta)$
- Where
  - $I_0$  = Emission from bulk material
  - $\theta$  = Emission angle (with respect to sample normal)
  - $d$  = Film thickness
  - $\lambda$  = Attenuation length

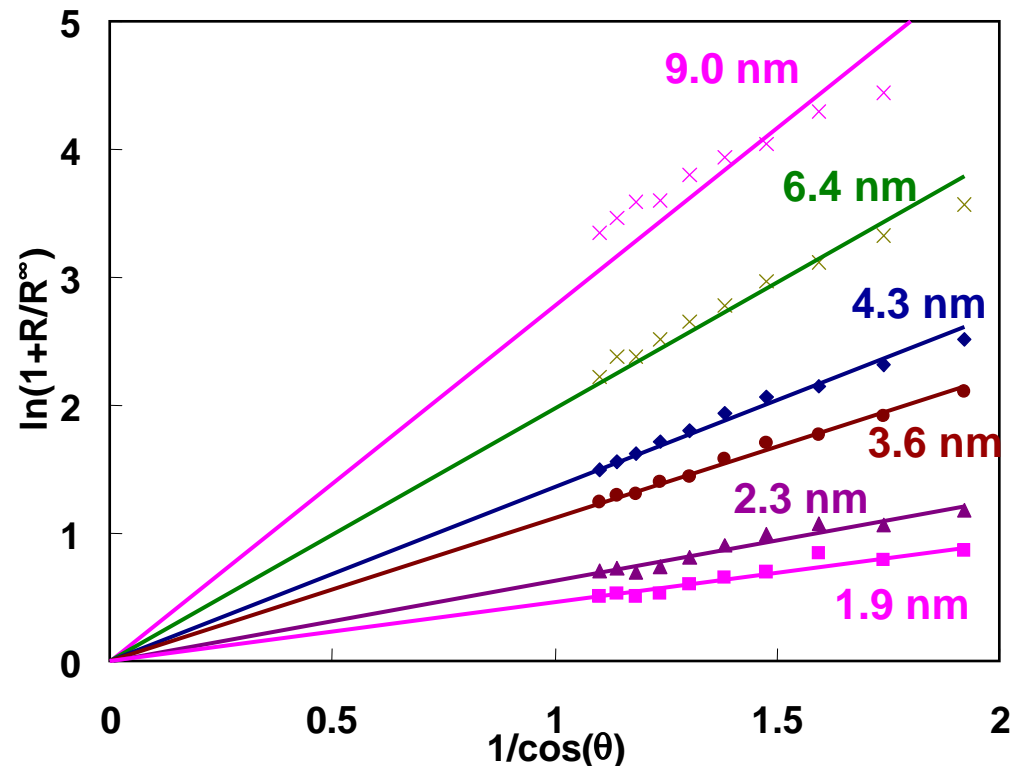
## Silicon dioxide on silicon

### Plot:

- $\ln[1 + R/R^\infty]$  vs.  $1/\cos(\theta)$

### Gradient

- $d/\lambda$



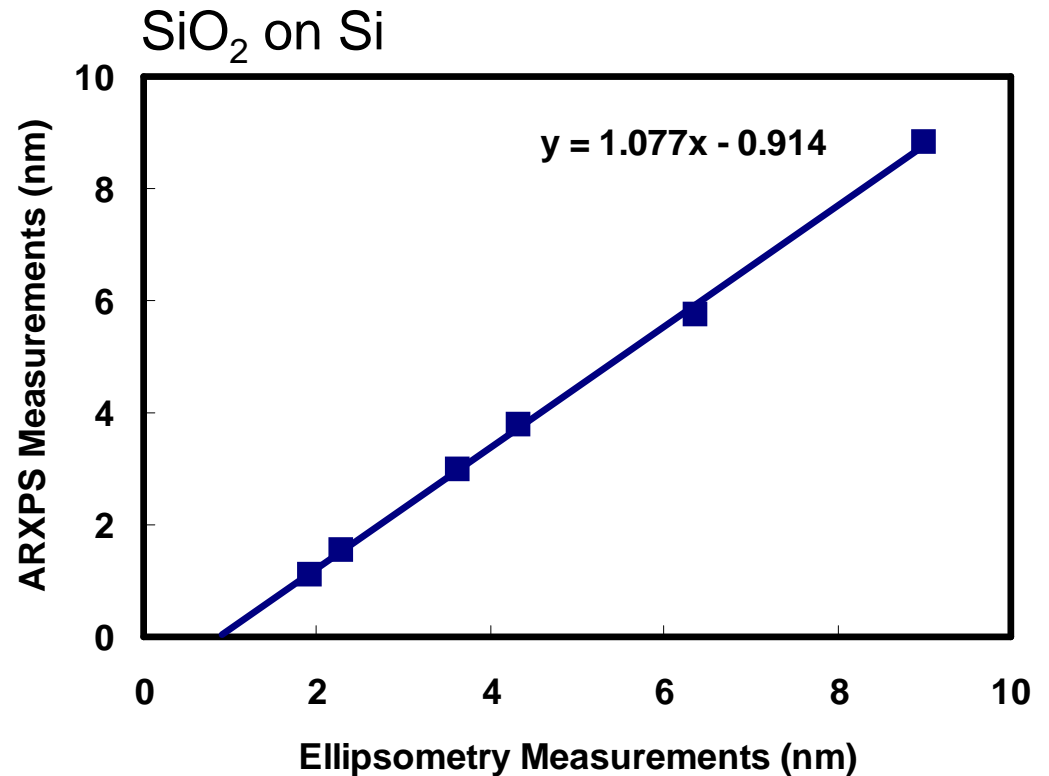
# Thickness Measurements –Single Layer

## ■ Equations

- Photoemission from a thin film
  - $I = I_0 [1 - \exp(-d/\lambda \cos\theta)]$
- Attenuation by a thin film
  - $I = I_0 \exp(-d/\lambda \cos\theta)$
- Where
  - $I_0$  = Emission from bulk material
  - $\theta$  = Emission angle (with respect to sample normal)
  - $d$  = Film thickness
  - $\lambda$  = Attenuation length

## ■ For thickness calculation

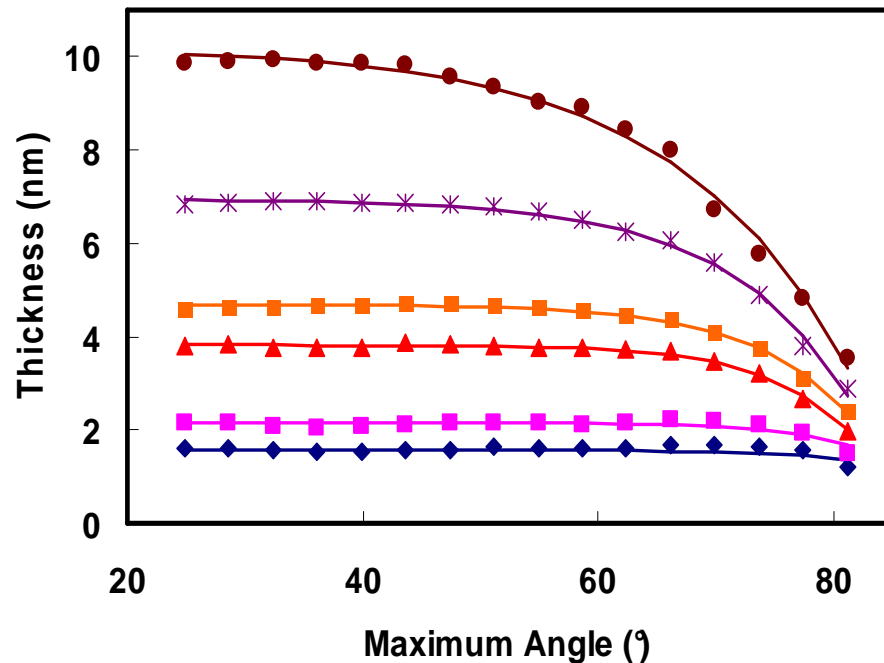
- $\ln[1 + R/R_0] = d/(\lambda_A \cos\theta)$



## ■ Beware of $R_0$

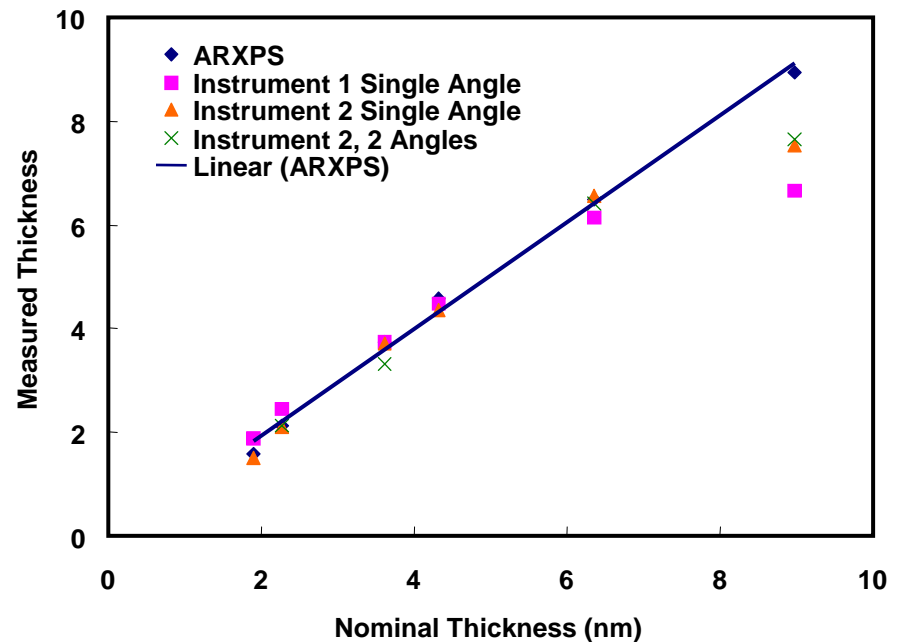
- For SiO<sub>2</sub>/Si experimental value is very different from calculated value

# XPS Measurements of SiO<sub>2</sub> Thickness

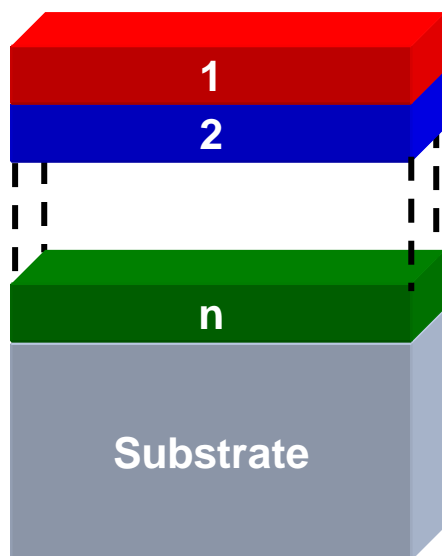


- ARXPS measurements
  - Effect of angular range upon measured thickness
  - Minimum angle is 23° in all cases
  - Highest usable maximum angle depends upon oxide thickness

- Comparison of ARXPS with fixed angle XPS
  - Good agreement except at large thickness
  - Single angle measurement samples large angular range.

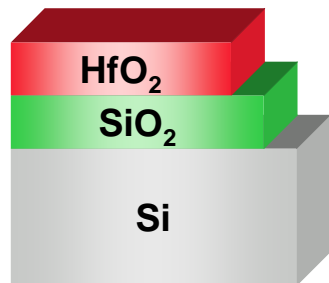


# Multiple Overlayers



- Choose XPS transitions representing the composition of each layer
- Measure signals as a function of angle
- Determine intensity ratios
  - $I_j(\theta)/I_{j+1}(\theta)$
  - $I_j(\theta)/I_{\text{sub}}(\theta)$
  - $I_j(\theta)$  is the XPS signal from layer  $j$  as a function of angle
- Fit theoretical ratios to measured ratios using layer thickness as fitting parameter
- Best results are obtained by finding the best fit to all of the data simultaneously

# Layer Thickness Calculation



**Multi-Overlayer Calculator**

Maximum Angle: 62.38° Instrument Type: ThetaProbe X-rays:  Al  Mg

Recipe Name: HfO2-SiO2-Si Save New

Units:  nm  Å

Number of layers	Color	XPS Peak	Chemical Formula	Use	Calculated Depth
1	Overlayer 1	Hf4f	HfO2	<input type="checkbox"/>	1.43
2	Overlayer 2	Si2pOx	SiO2	<input checked="" type="checkbox"/>	0.971
3	Overlayer 3			<input type="checkbox"/>	
	Substrate	Si2p3	Si	<input checked="" type="checkbox"/>	

Electron Attenuation... Material Properties...

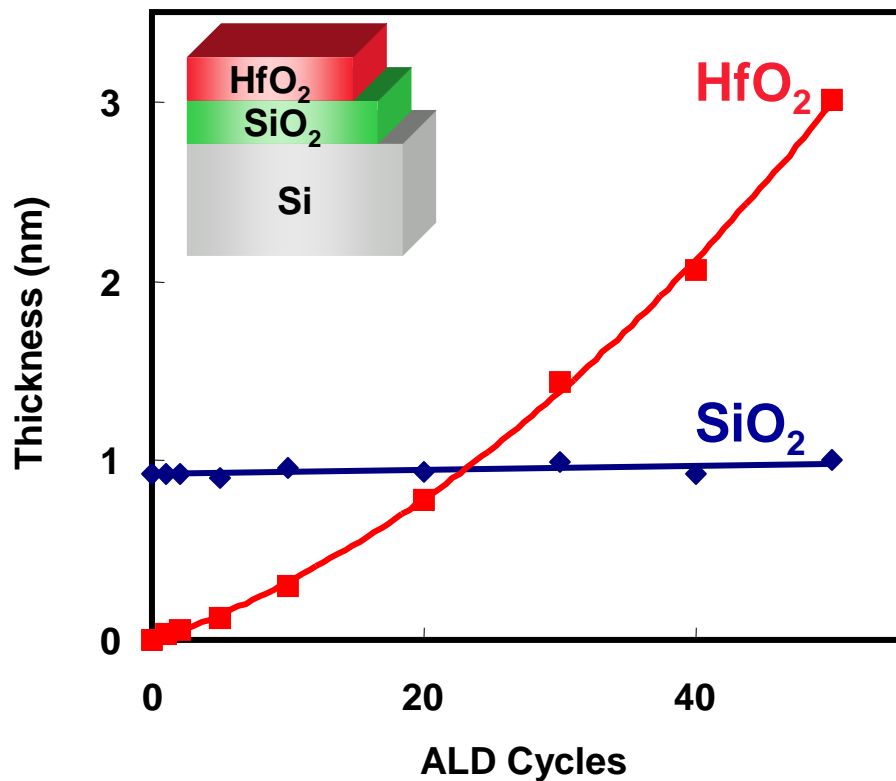
Navigator: << < > >>  Show Graph Calculate Cancel Accept

The graph shows the relationship between  $\alpha$  (y-axis, logarithmic scale from 0.1 to 10) and  $\phi$  (x-axis, linear scale from 20 to 70). Three data series are plotted: Hf4f/Si2p3 (red diamonds), Si2pOx/Si2p3 (orange diamonds), and Hf4f/Si2pOx (red asterisks). Each series shows a characteristic curve that increases with  $\phi$ .

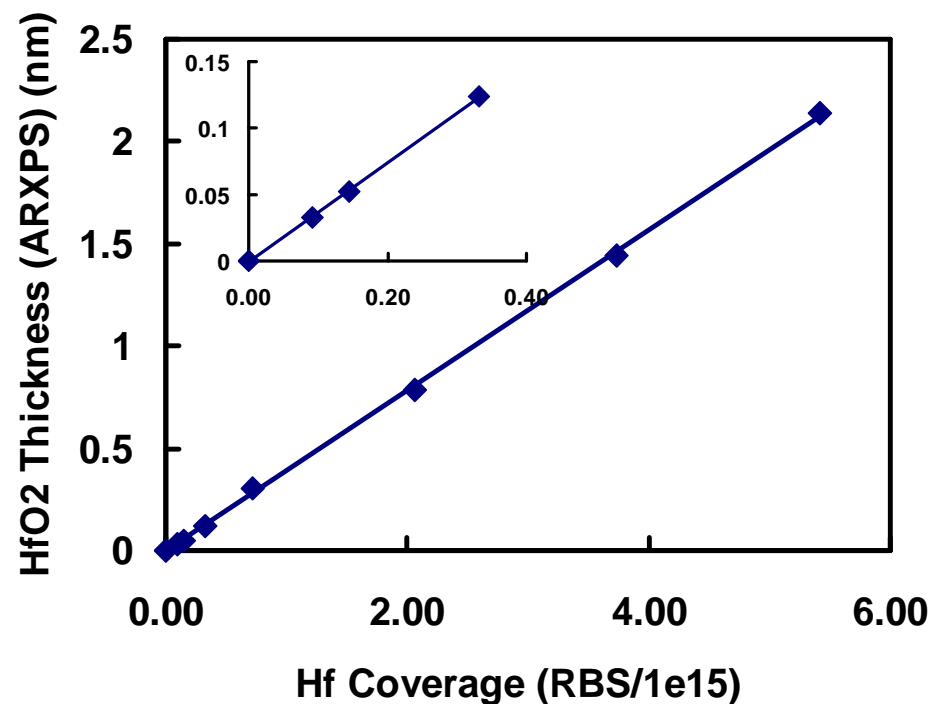
Layer Thickness (nm)



# HfO<sub>2</sub> Growth on Thermal SiO<sub>2</sub>



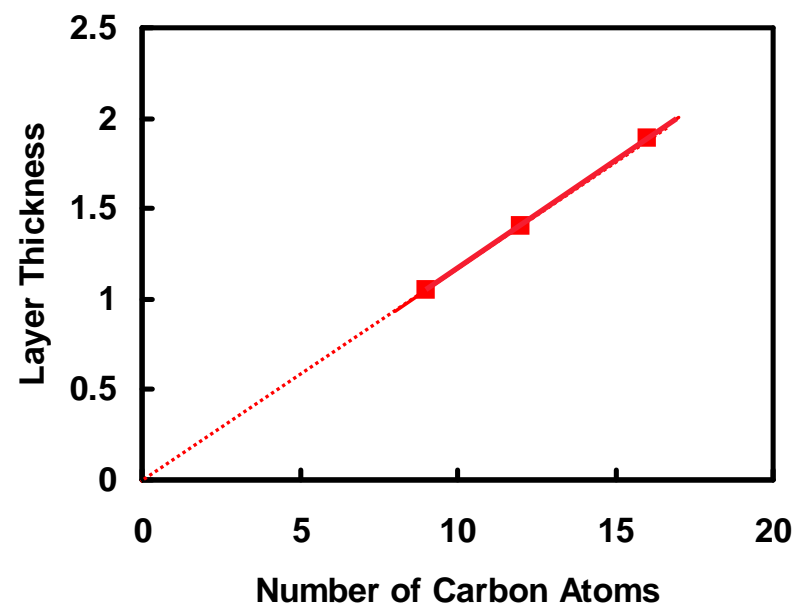
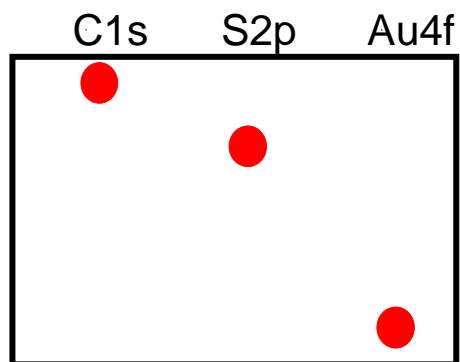
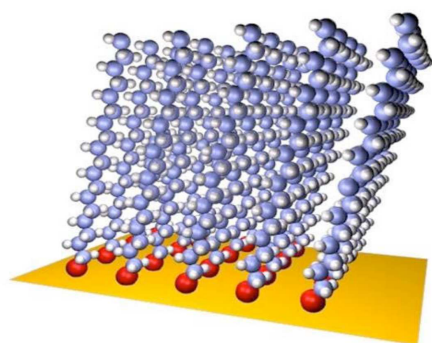
- Thickness calculated from PARXPS data using multi-layer thickness calculator
- Increasing growth rate
- Constant SiO<sub>2</sub> thickness



# Thickness Measurement of SAMs Using PARXPS

- Measurements from 3 Alkanethiols deposited on gold

- $C_9H_{19}SH$
- $C_{11}H_{23}SH$
- $C_{16}H_{33}SH$



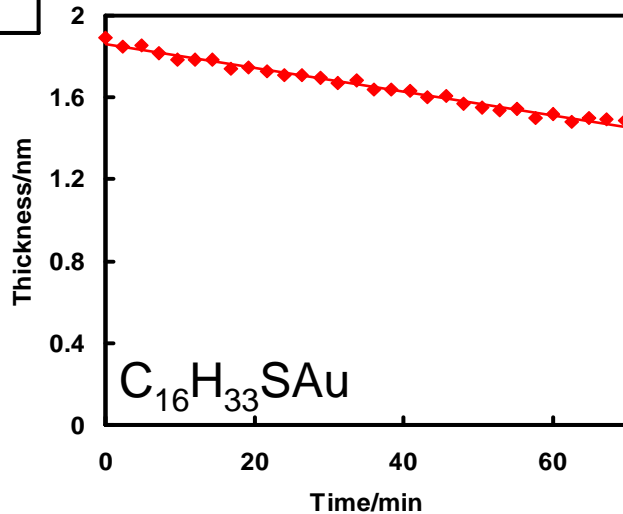
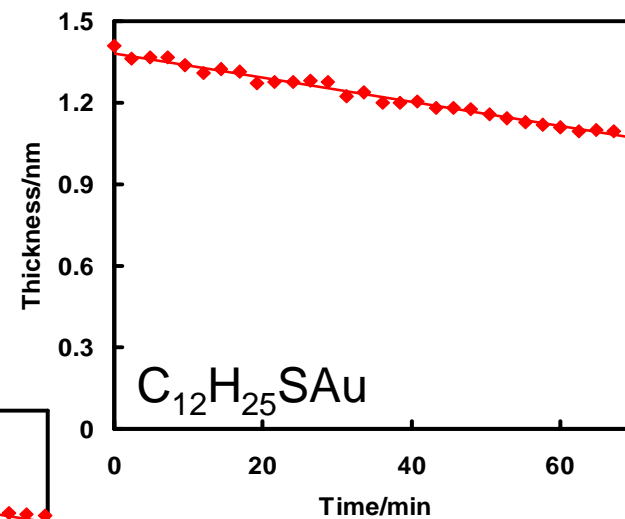
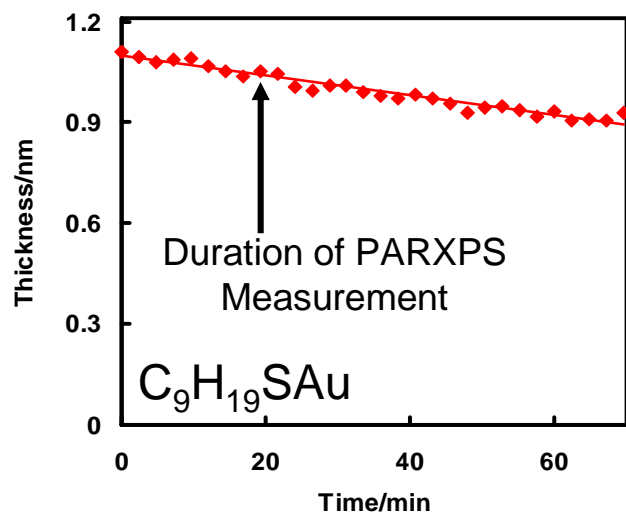
- Acquisition Times

- C 1s            3 min
- Au 4f           1 min
- S 2p            15 min

# Thickness Measured as Function of Time

## ■ Conditions

- Angle integrated
- Acquisition time per point = 1.25 min.

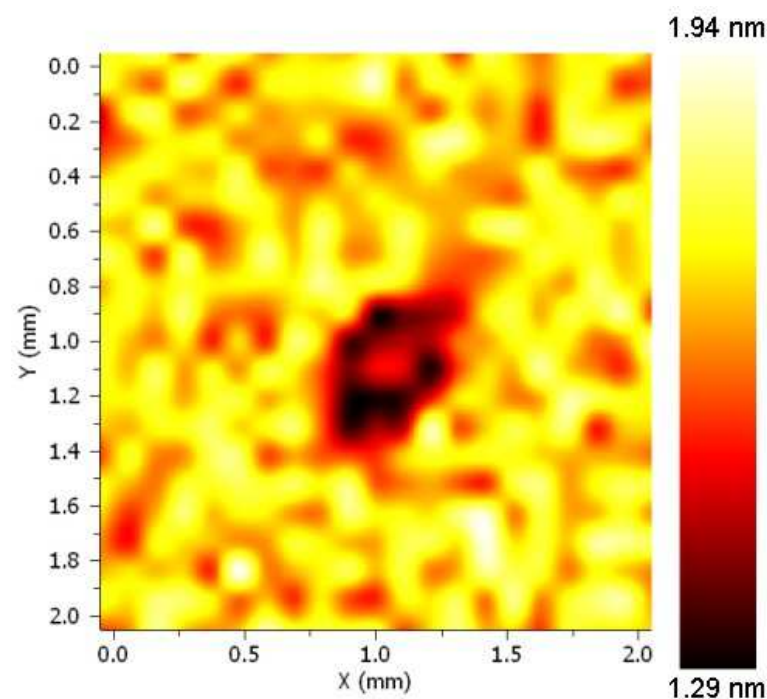


~20% Decrease  
in 70 minutes

# Thickness Map

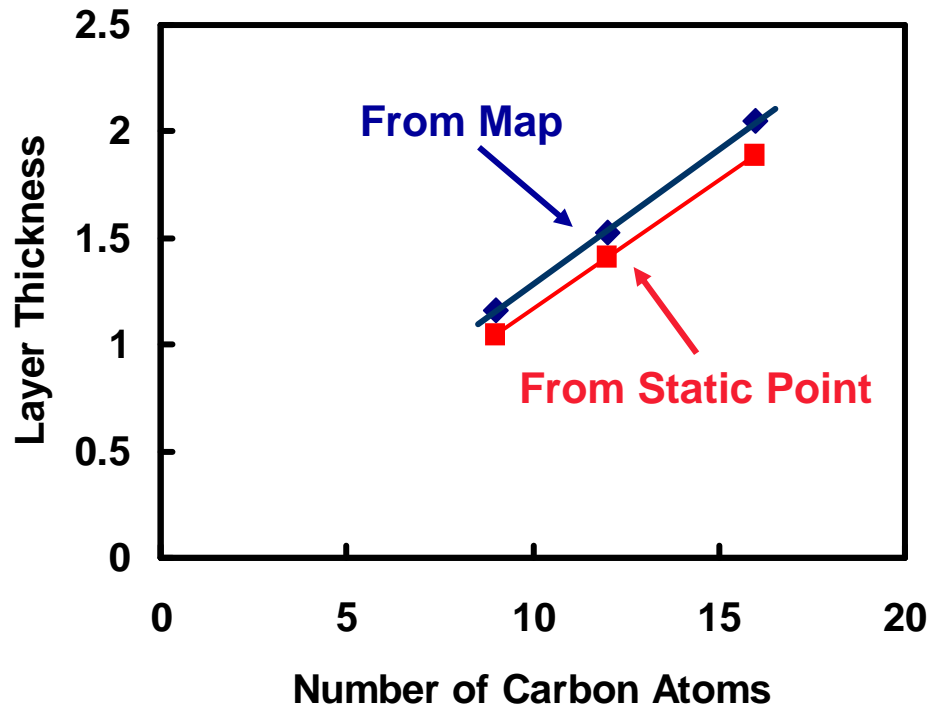
## ■ Conditions

- Sample  $C_{16}H_{33}SAu$
- Angle integrated
- Snapshot
- 20 x 20 pixels
- 100  $\mu m$  spot size
- Time per point 3 seconds



- Clear evidence for X-ray damage caused during ARXPS measurement

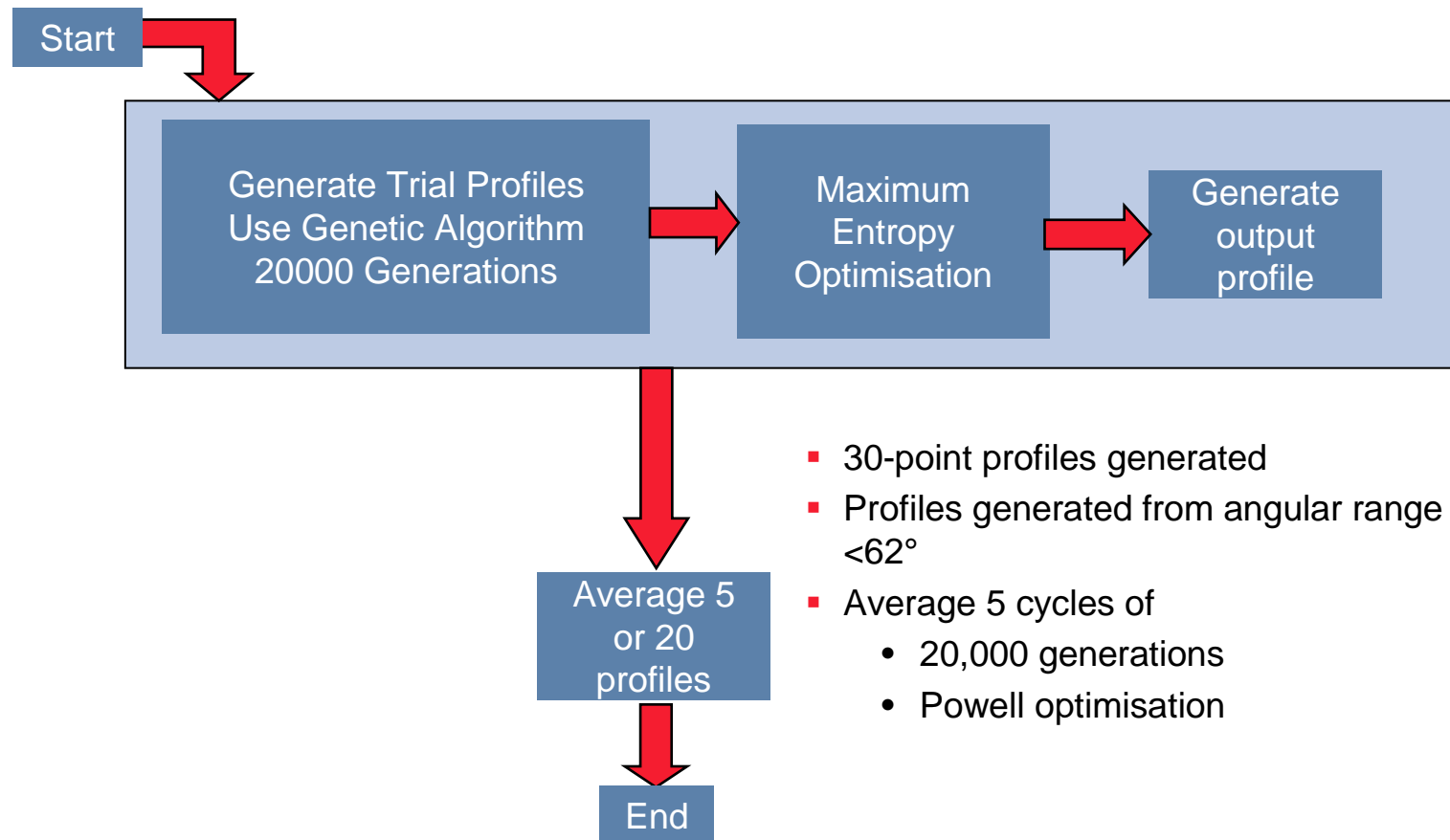
# Thickness Measurement



- ARXPS can be applied to delicate samples by mapping the sample and summing the data.
- Only feasible with PARXPS

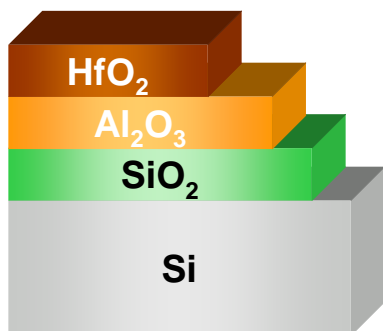
# Generation of Depth Profiles

- Summary of the Maximum Entropy method

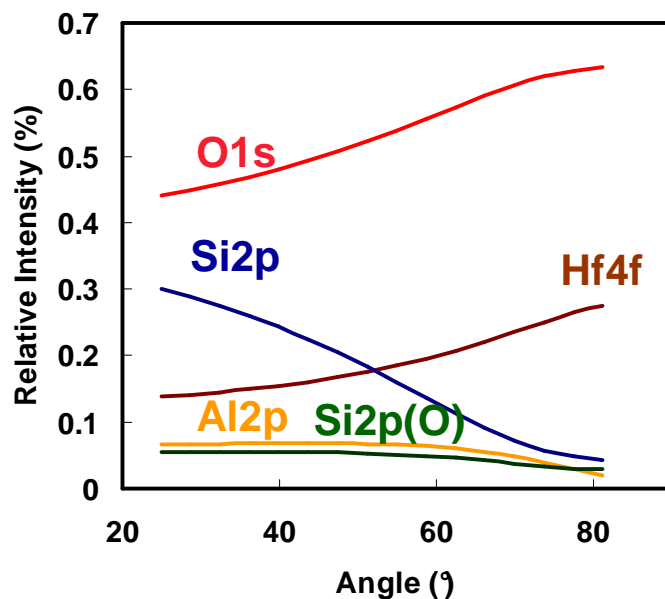
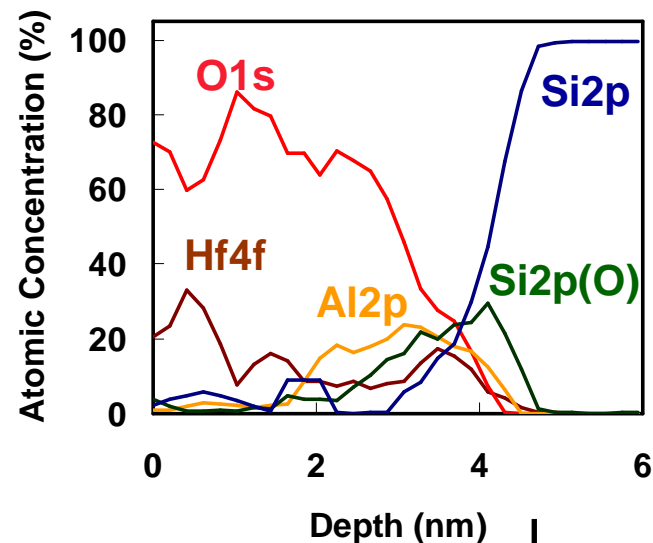


# Depth Profile Generation

Sample



Generate Random Profile

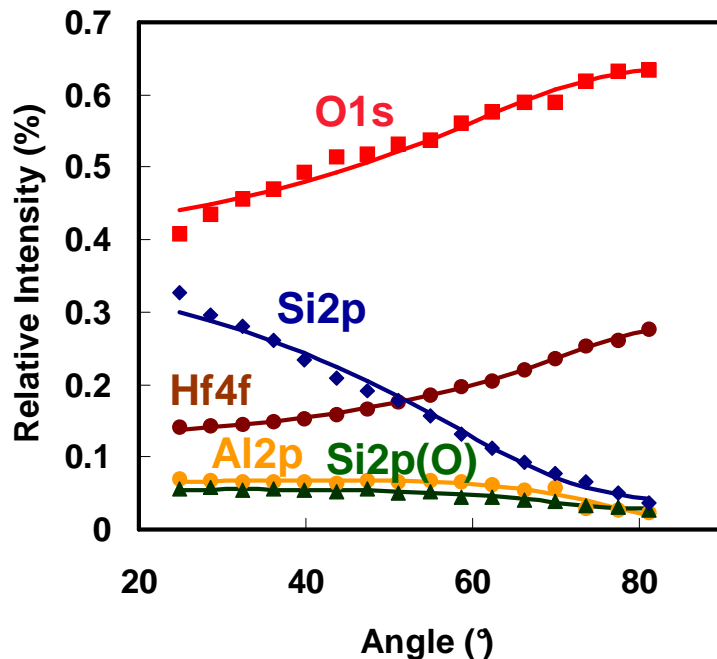


Calculate Expected ARXPS Data (Beer Lambert Law)

$$T_j(\theta) = \exp(-t/\lambda \cos\theta)$$

# Depth Profile Generation (2)

Determine error between observed and calculated data:



$$\chi^2 = \sum_k \frac{(I_k^{calc} - I_k^{obs})^2}{\sigma_k^2}$$

- Calculate the entropy associated with a particular profile (the probability of finding the sample in that particular state)

$$S = \sum_j \sum_i c_{j,i} - c_{j,i}^0 - c_{j,i} \log \left( \frac{c_{j,i}}{c_{j,i}^0} \right)$$

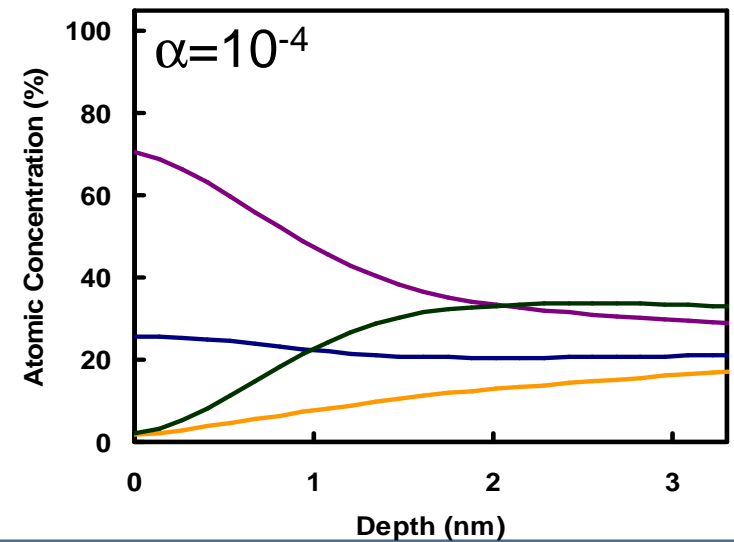
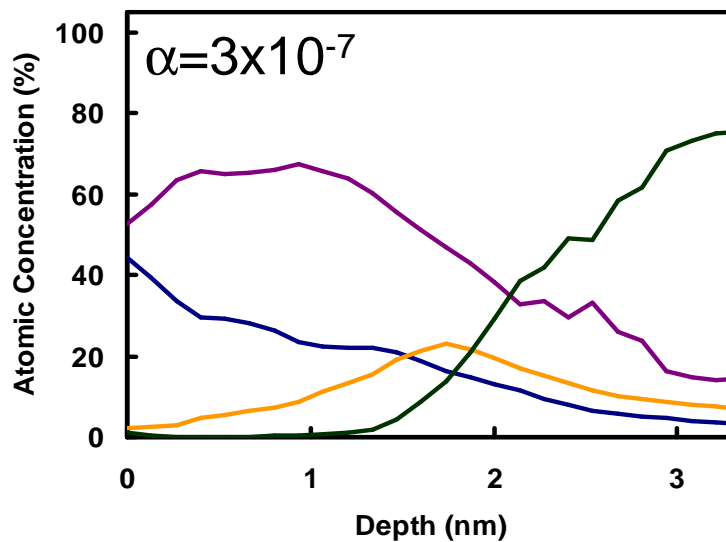
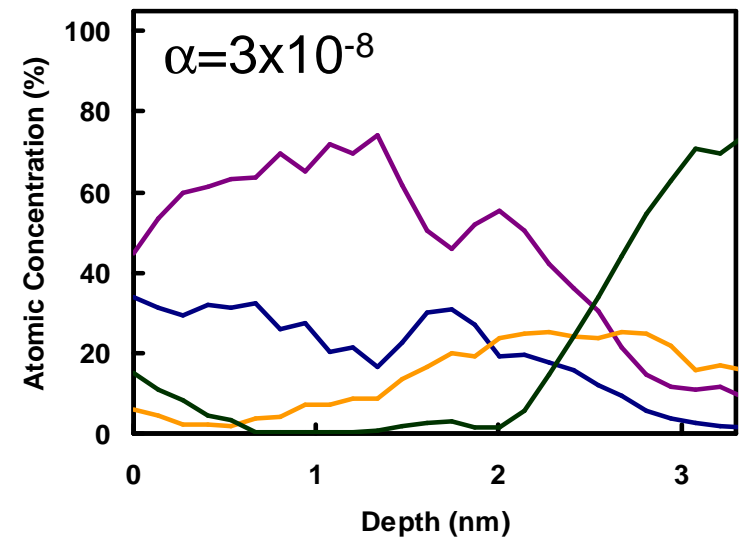
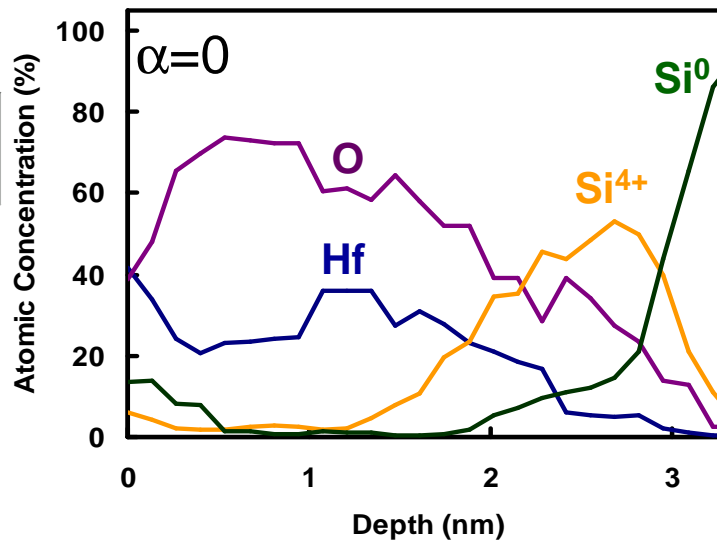
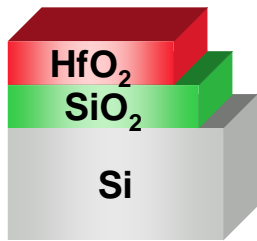
- $c_{j,i}$  is the concentration of element  $i$  in layer  $j$
- Maximise the joint probability function

$$Q = \alpha S - 0.5 \chi^2$$

- Repeat process to obtain most likely profile



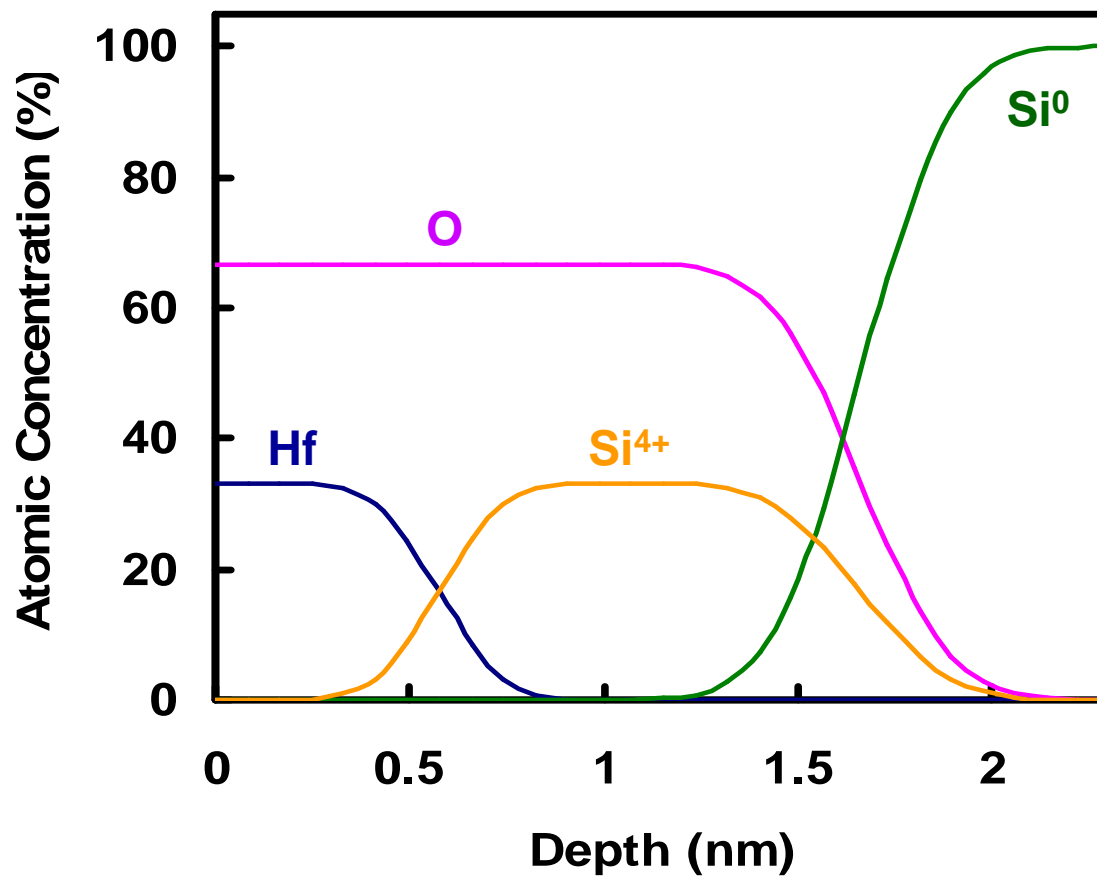
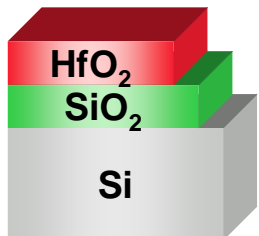
# Effect of Alpha on Generated, Unconstrained Profile



# Add Constraints and Automate

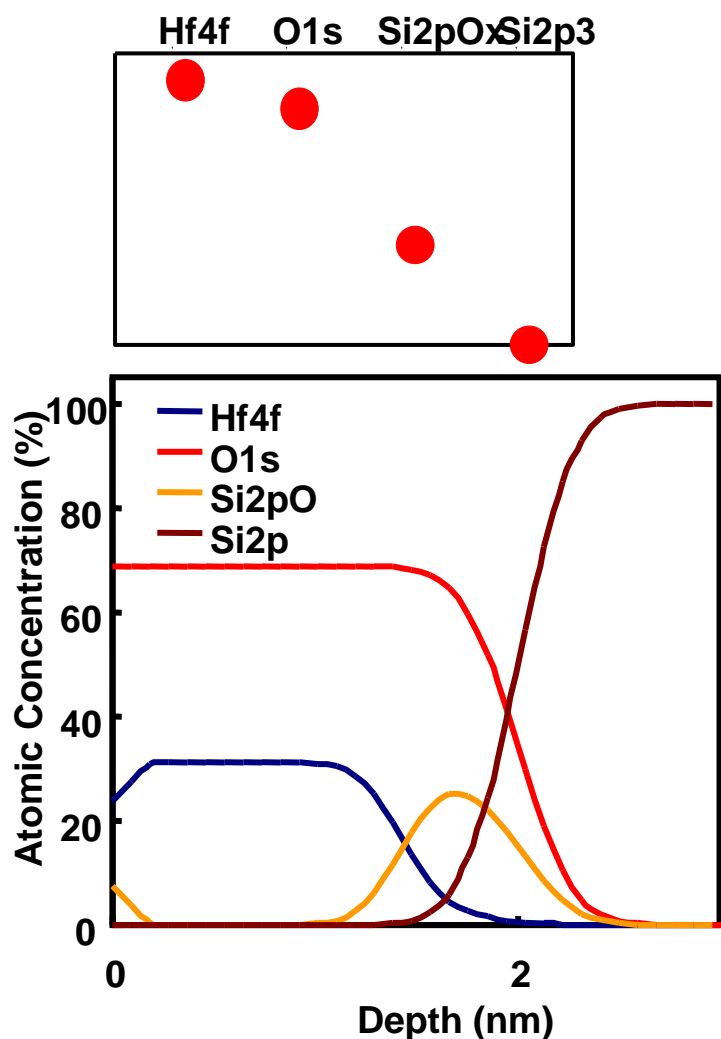
- Need to apply constraints to prevent chemically unreasonable solutions (analogy to spectrum peak fitting)
  - We know the composition of the substrate
  - Assume mixtures of stoichiometric components (“Fit Units”)
    - Examples
      - $\text{HfO}_2$  and  $\text{SiO}_2$
      - $\text{SiO}_x\text{N}_y = (\text{SiO}_2)_a + (\text{Si}_3\text{N}_4)_b$
    - Non-stoichiometric components / “Free” oxygen
- Examine data to obtain the optimum value for ‘ $\alpha$ ’ (automated)
- Choose most appropriate angular range (automated)
  - Depends upon layer thickness

# Use Fit Units

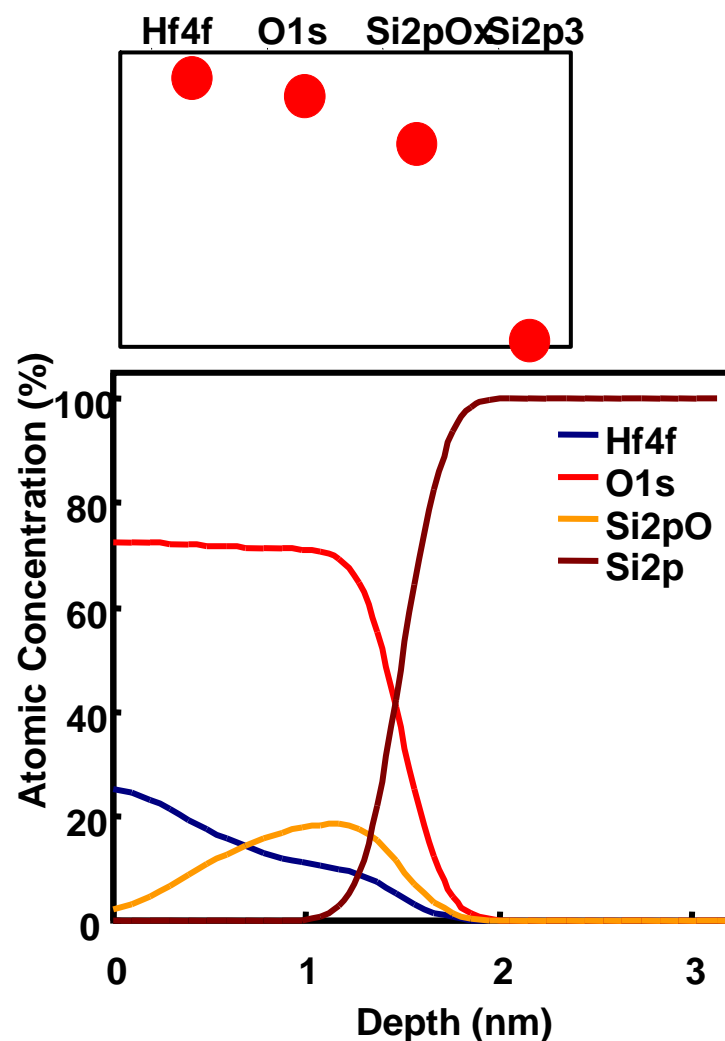


# Effect of Interlayer on 30 Cycle ALD Layer

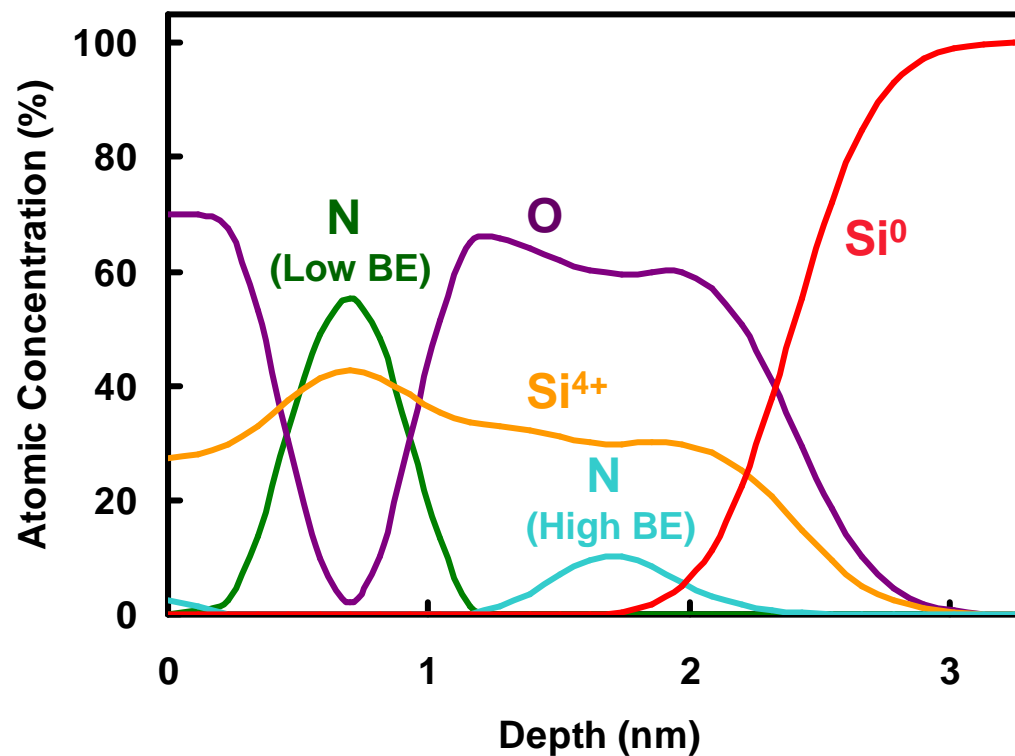
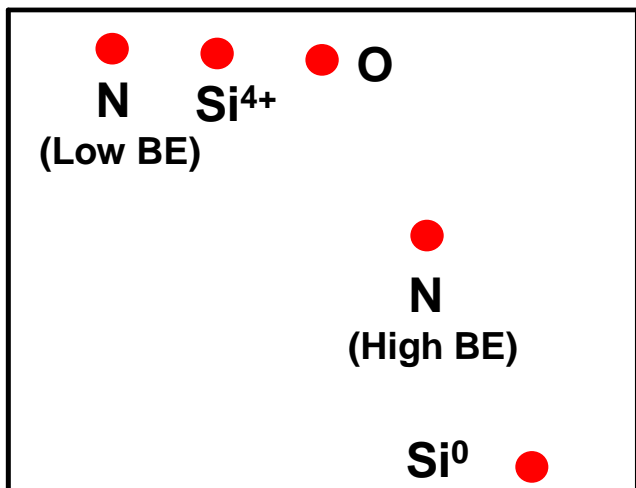
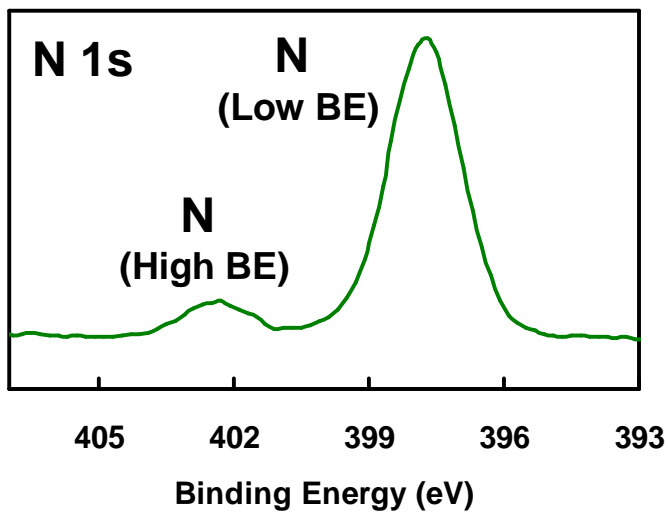
■ Grown on thin SiO<sub>2</sub> layer



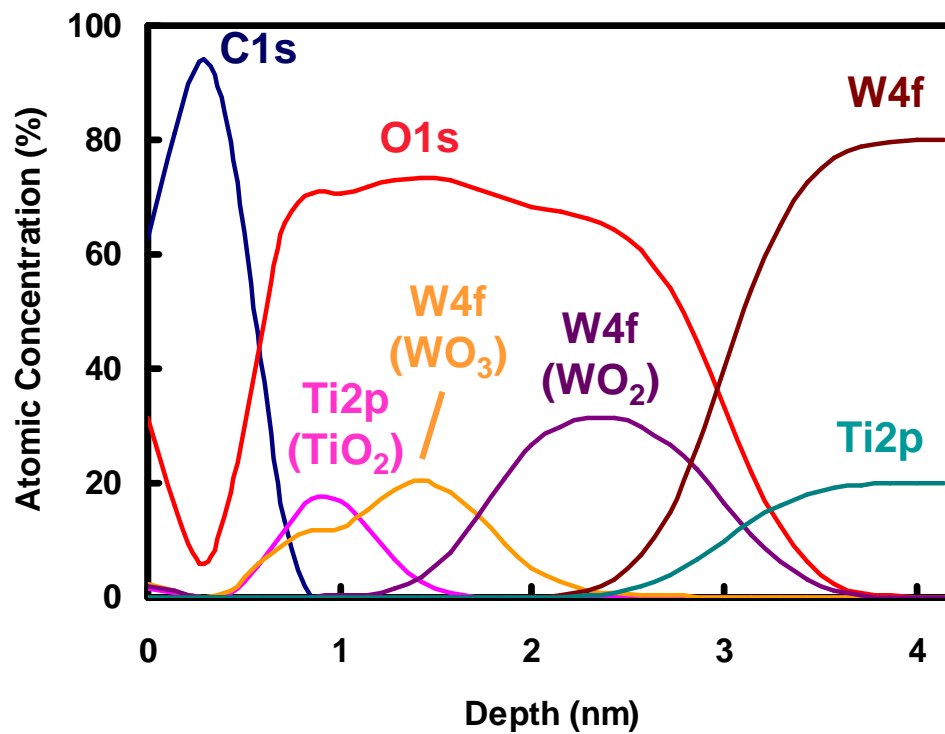
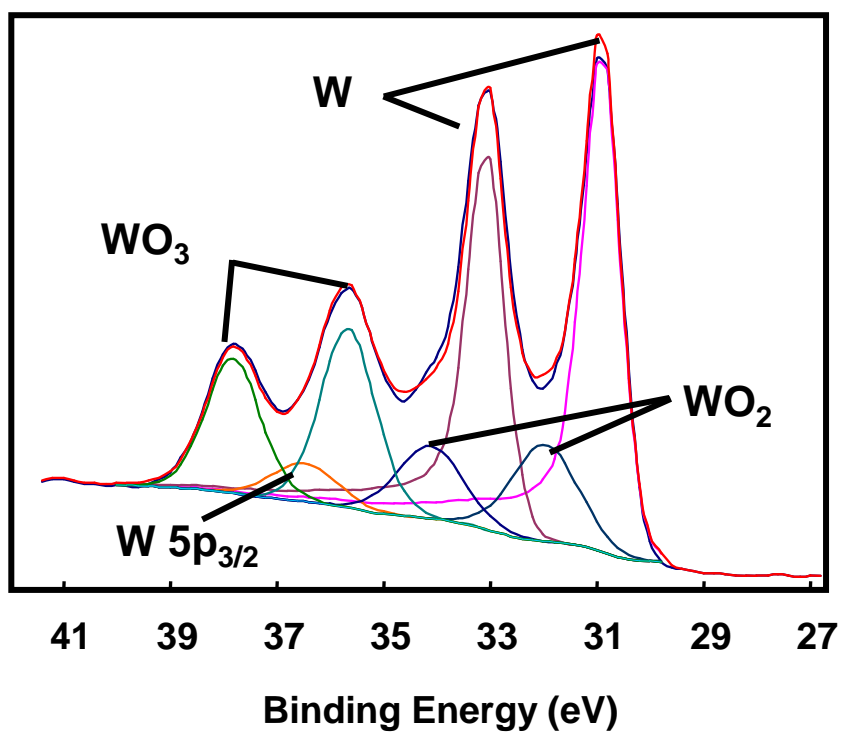
■ Grown on HF last surface



# SiON Chemical State Profile

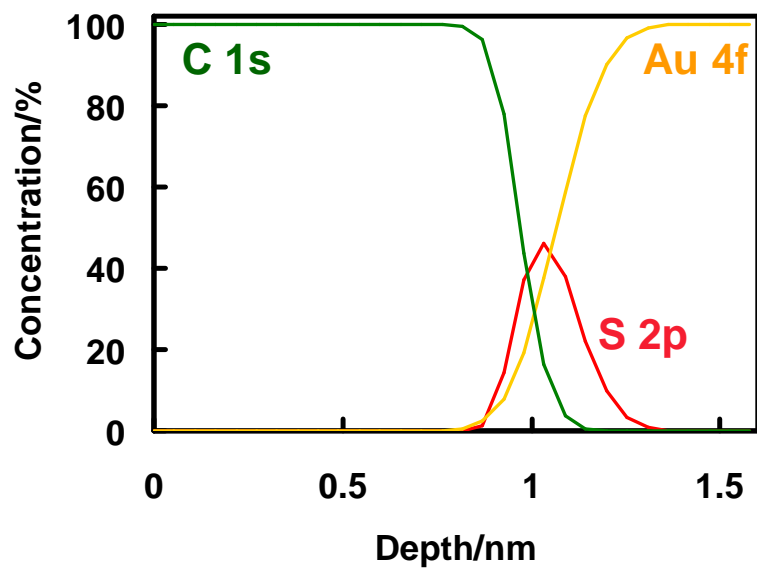
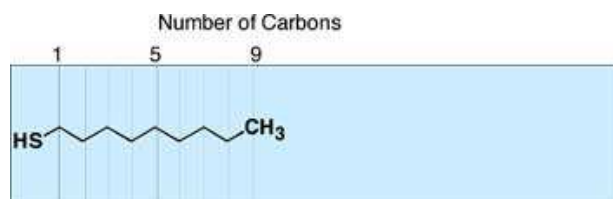


# Ti/W Alloy

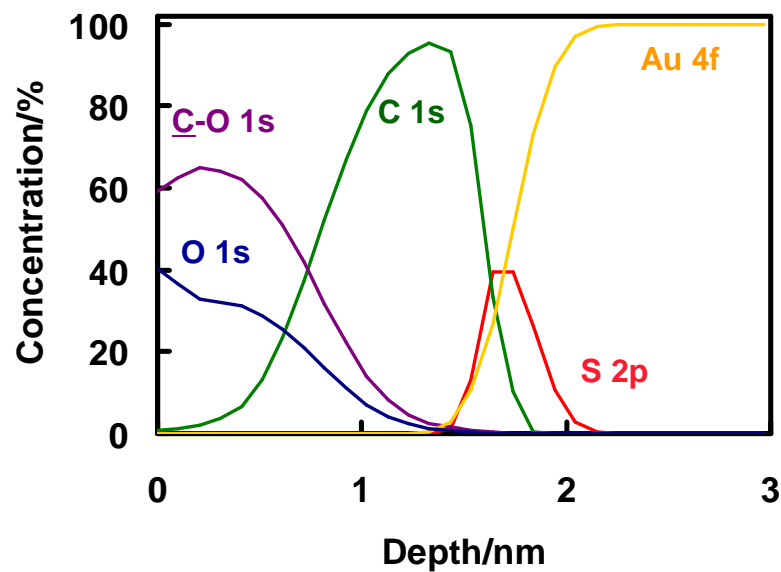
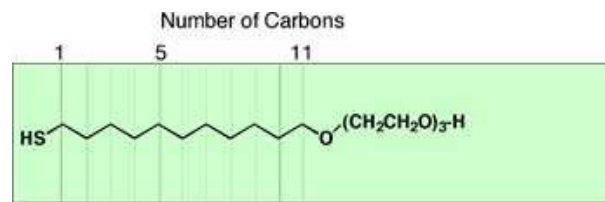


# Profiles from SAMs

Nonanethiol

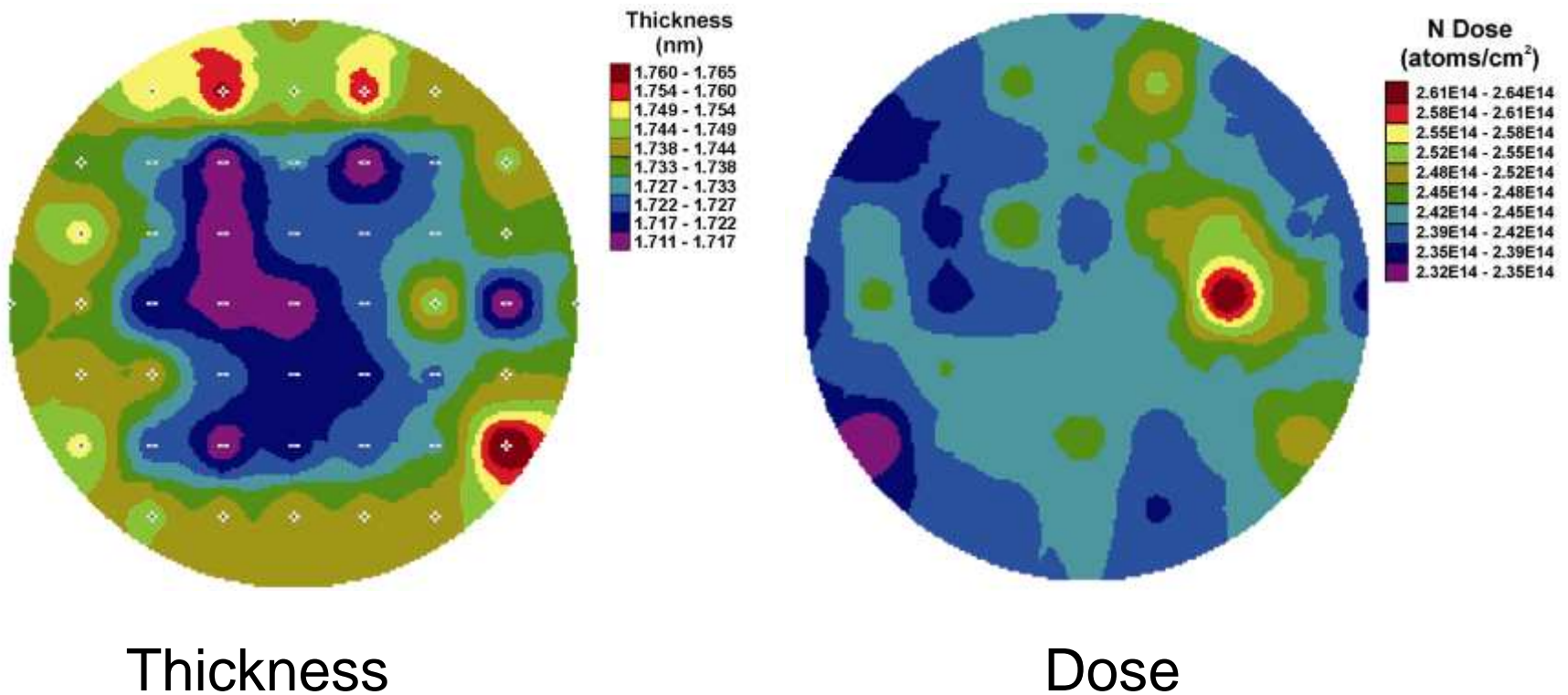


1-Mercapto-11-undecyl-tri(ethylene glycol)



# Nitrogen Dose and Thickness

- 300 mm wafer
- Single measurement
- 49-point maps





# Conclusions

- Angle Resolved XPS is a powerful tool for the characterisation of ultra-thin films
  - Layer ordering
  - Multiple layer thickness determination
  - Depth profiles
- Parallel ARXPS extends the capabilities of the technique
  - Small features
  - Large samples
  - Mapping
  - *Larger number of angles*

# Acknowledgements

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- Dr D Graham, Asemblon, USA
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